3535 UVC LED Datasheet



Features:

Slim Size SMD Package: Design Flexibility Purity UVC/UVB Chip: 270-280nm, 310nm High Purity Ceramic Base Low Thermal Resistance Better Heat Dissipation Enviromental Friendly; ROHS Compliance Customized Service Available

Applications:

Water Purification, Sterilization Humidifier... Surface Disinfection, Air Sterilization... LED Aquarium Light, LED Plant Growing Light..

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PRODUCT NAMING RULES

XXXX	XX	Х	Х	ХХ	G
Туре	Color	Wavelength	Beam Angle	Radiant Flux	Product Series
3535	UVC: 270-280nm	275nm	0: 120°	02: 2-4mW	G
	UVB: 310nm	310nm	6: 60°	08: 8-12mW	S

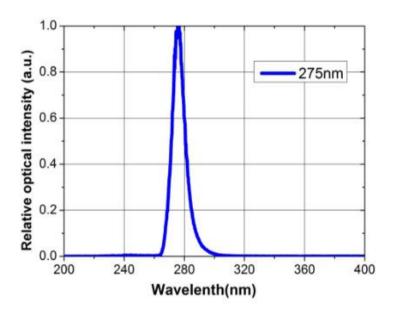
CHARACTERISTICS

SPECIFICATIONS (Ta=25°C)				
Peak Wavelength	Forward Voltage	Radiant Flux	Part Number	
Peak wavelength	Forward Voltage	@ 40mA		
270-280nm	5.0-7.0V	2-4mW	3535UVC002G	

Parameters	Symbol	Value	Unit
Forward Current	I _F	40	mA
Power Dissipation	P _D	260	mW
Peak Wavelength	λp	270-280	nm
Viewing Angle	20 1/2	120	Deg
FWHM	Δλ	12	nm
Thermal Resistance	RØj-b	18	°C/W
Operating Temperature	T _{opr}	-30 ~ +60	°C
Storage Temperature	T _{stg}	-30 ~ +100	°C
Reflow Sodering Temperature	T _{SLD}	170-180	°C

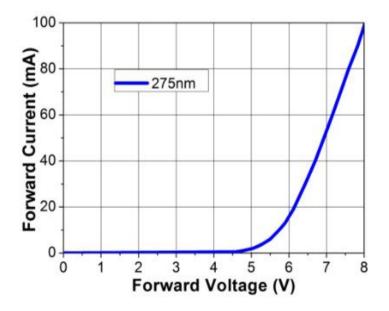
TYPICAL CHARACTERISTIC CURVES

Relative Characteristics Curves (Tc=25°C)



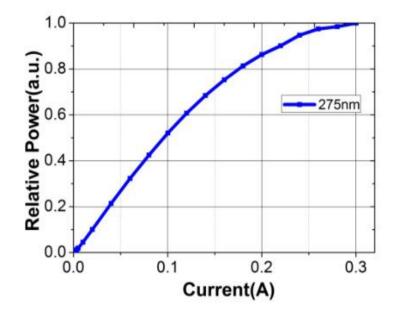
Spectral Characteristic (IF=40mA)

Forward Current vs. Forward Voltage



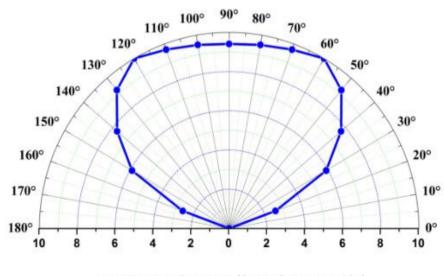
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TYPICAL CHARACTERISTIC CURVES



Relative Radiant Flux vs. Forward Current

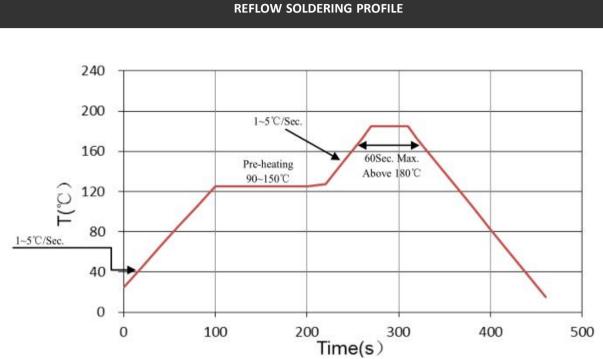
Typical Emission Distribution Curve



Viewing angle: 120° (for reference only)

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REFLOW SOLDERING PROFILE

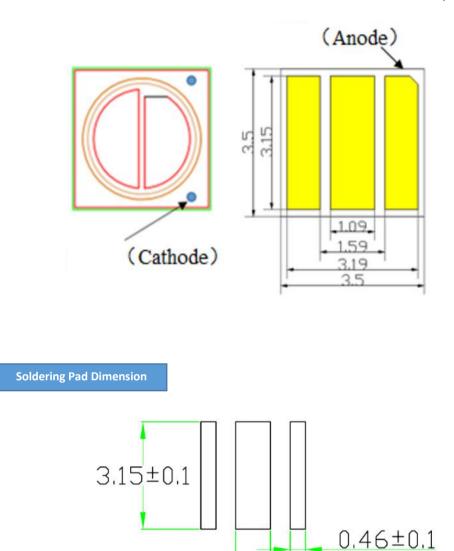


- 1) Temperature Profile should be the scene of the solder paste used type, proportion, reflow soldering equipment to change and adjust accordingly;
- 2) Inappropriate reflux temperature, reflux time may cause the LEDs welding failure. Suggest to do more testing before mass production, to ensure optimum technological parameters;
- 3) Reflow soldering should not be done more than two times;
- 4) When soldering, do not put stress on the LEDs during heating;
- 5) After soldering, do not warp the circuit board.

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used . It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

DIMENSIONS

Unit: mm, Tolerance: +/-0.1mm



Notes :

*All dimensions are in millimeters.(tolerance:±0.1mm)

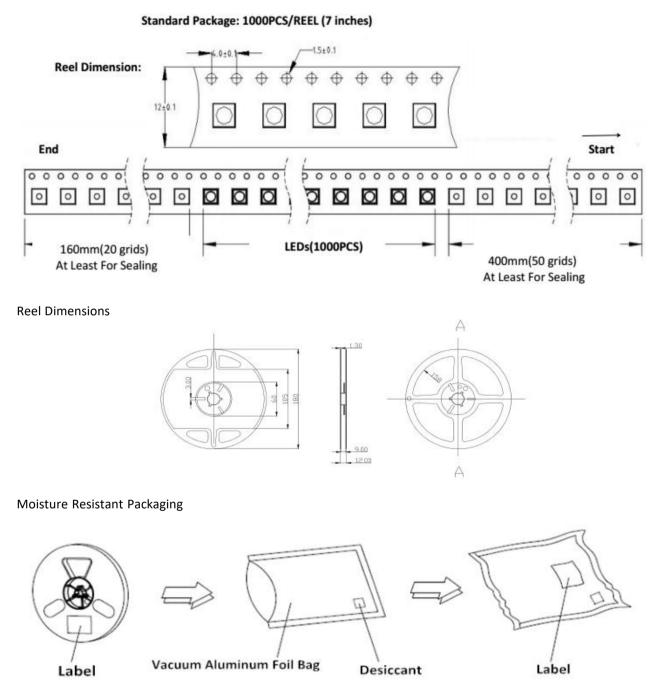
*The appearance and specifications of the product may be changed for improvement without notice.

0.6±0.1

1.05±0.1

PACKAGING

Tape Specifications (Units : mm)



1) Moisture-Proof Package

The moisture in the SMD package may vaporize and expand during soldering. The moisture can damage the optical characteristics of the LEDs due to the encapsulation.

2) During Storage

Conditions		Temperature	Humidity	Time	
Storage	Before Opening Aluminum Bag	5°C~30°C	<50% RH	Within 1 Year from the Delivery Date	
Storage	After Opening Aluminum Bag	5°C~30°C	<60% RH	= 672 hours</td	
	Baking	65+/-5°C	<10% RH	10~24 hours	

3) During Usage

3.1 The LED should avoid direct contact with hazardous materials such as sulfur , chlorine, phthalate, HF, etc.

- 3.2 The metal parts on the LED can rust when exposed to corrosive gases. Therefore, exposure to corrosive gases must be avoided during operation and storage;
- 3.3 Extreme environments such as sudden ambient temperature changes or high humidity that can cause condensation must be avoided.

4) Cleaning

- 4.1 Do not use brushes for cleaning or organic solvents for washing as avoid residue of organic solvent;
- 4.2 IPA is the recommended solvent for cleaning the LEDs under the following conditions;
- 4.3 Ultrasonic cleaning is not recommended;
- 4.4 Pretests should be conducted with the actual cleaning process to validate that the process will not damage the LEDs.

5) Thermal Management

- 5.1 The thermal design of the end product must be seriously considered, particularly at the beginning of the system design process;
- 5.2 The generation of heat is greatly impacted by the input power, the thermal resistance of the circuit boards and the density of the LED array combined with other components.

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6) Static Electricity

- 6.1 Wristbands and anti-electrostatic gloves are strongly recommended and all devices, equipment and machinery must be properly grounded when handling the LEDs, which are sensitive against static electricity and surge;
- 6.2 Precautions are to be taken against surge voltage to the equipment that mounts the LEDs;
- 6.3 Unusual characteristics such as significant increase of current leakage, decrease of turn-on voltage, or non-operation at a low current can occur when the LED is damaged.

7) Electrostatic Discharge (ESD)

- 7.1 The LEDs are sensitive to static electricity or surge voltage and current. The electrostatic Discharge can damage a LED Chip. Also, It can be affect a reliability belong to the life time of LED package. When handling LEDs, the following measures against ESD are actively recommended:
- A) Please wear a wrist strap, anti-static clothes, foot wear and gloves;
- B) Please set up a grounded or anti-static paint floors, a grounded or the ability to surge protection-workstation equipment and tools;
- C) ESD protection-worktable/bench, mat made of a conductive materials.

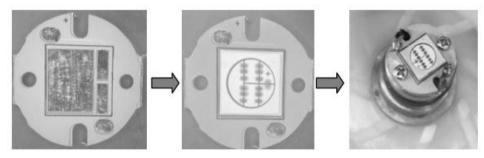


- 7.2 An appropriate grounding is required for all devices, equipment, and machinery used in product assembly. Please apply surge protection after review when designing of commercial products (Curing Module, etc.);
- 7.3 If tools or equipment contain insulating materials such as glass or plastics, the following measures against ESD are strongly recommended;
- A) Dissipating static charge with conductive materials;
- B) Preventing charge generation with moisture;
- C) Plug in the ionizing blowers (ionizer) for neutralizing the charge.
- 7.4 The customer is advised to check if the LEDs are damaged by ESD when performing the characteristics inspection of the LEDs in the application.
- 7.5 ESD damaged LEDs may have a current flow at a low voltage.

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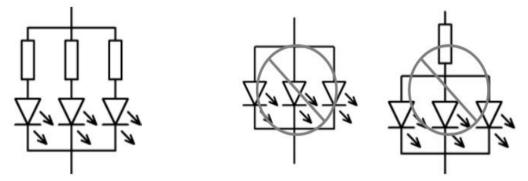
8) Recommended Circuit

- 8.1 The current through each LED must not exceed the absolute maximum rating when designing the circuits;
- 8.2 The LEDs before use must first be welding on the aluminum heat sink or copper heat sink, to avoid overheating LEDs damage.



8.3 In general, there can be various forward voltages for LEDs. Different forward voltages in parallel via a single resistor can result in different forward currents to each LED, which also can output different luminous flux values. In the worst case, the currents can exceed the absolute maximum ratings which can stress the LEDs.

Matrix circuit with a single resistor for each LED is recommended to avoid the luminous flux fluctuations.



- 8.4 The driving circuits must be designed to operate the LEDs by forward bias only.
- 8.5 Reverse voltages can damage the zener diode, which can cause the LED to fail.
- 8.6 A constant current LED driver is recommended to power the LEDs.

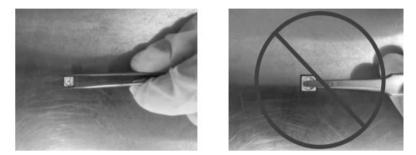
9) Eye Safety Guidelines

- 9.1 Do not directly look at the light when the LEDs are on;
- 9.2 Proceed with caution to avoid the risk of damage to the eyes when examining the LEDs with optical instruments.



10) Manual handling

10.1 Use Teflon-type tweezers to grab the base of the LED and do not apply mechanical pressure on the surface of the encapsulant.



11) Disclaimers

- 11.1 Avonec is not responsible for any damages ar accidents caused if the operating or storage conditions exceed the absolute maximum ratings recommended in this document;
- 11.2 The LEDs described in this document are intended to be operated by ordinary electronic equipment;
- 11.3 It is recommended to consult with Jason when the environment or the LED operation is non-standard in order to avoid any possible malfunctions or damage to product or risk of life or health;
- 11.4 Disassembly of the LED products for the purpose of reverse engineering is prohibited without prior written consent from Avonec. All defected LEDs must be reported and are not to be disassembled or analyzed.
- 11.5 The product information can be modified and upgraded without prior notice;
- 11.6 Any other matters not mentioned in this specification, please contact our consulting our sales department.